

3.0mmx1.5mm SMD CHIP LED LAMP

Part Number: APL3015CGCK-F01 Green

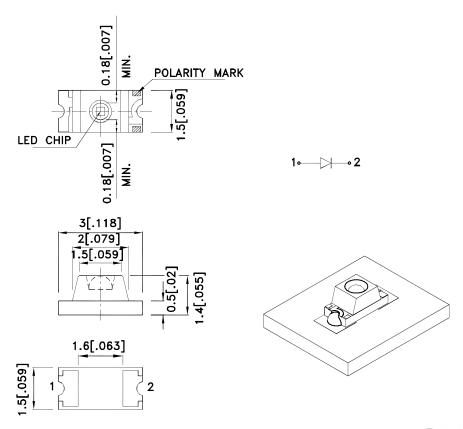
Features

- 3.0mmx1.5mm SMT LED, 1.4mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



SPEC NO: DSAF1071

APPROVED: WYNEC

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

REV NO: V.6B

CHECKED: Allen Liu

DATE: DEC/16/2012 PAGE: 1 OF 5 DRAWN: C.H.Han ERP: 1203001565

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APL3015CGCK-F01	Green (AlGalnP)	Water Clear	55	120	70°

Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	I=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.1	2.5	V	I=20mA
lR	Reverse Current	Green		10	uA	V _R =5V

Notes:

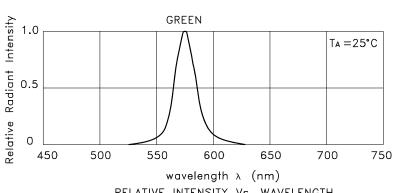
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units				
Power dissipation	75	mW				
DC Forward Current	30	mA				
Peak Forward Current [1]	150	mA				
Reverse Voltage	5	V				
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

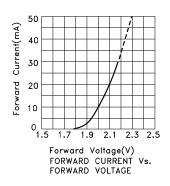
SPEC NO: DSAF1071 **REV NO: V.6B** DATE: DEC/16/2012 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: C.H.Han ERP: 1203001565

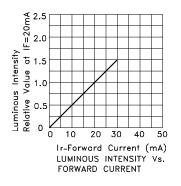


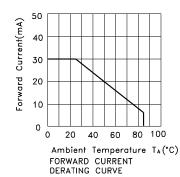
RELATIVE INTENSITY Vs. WAVELENGTH

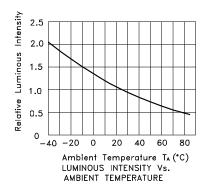
Green

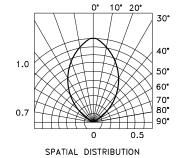
APL3015CGCK-F01









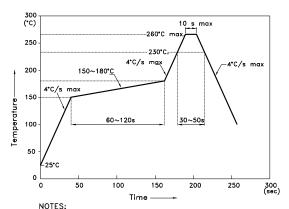


SPEC NO: DSAF1071 **REV NO: V.6B** DATE: DEC/16/2012 PAGE: 3 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: C.H.Han ERP: 1203001565

APL3015CGCK-F01

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



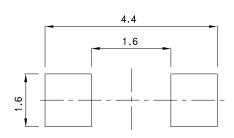
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

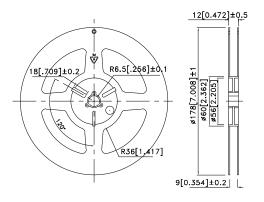
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

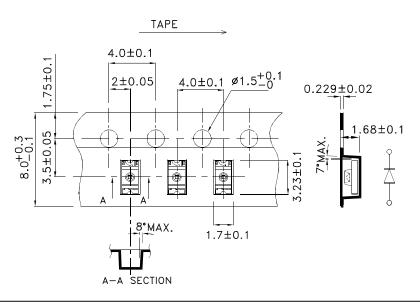
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



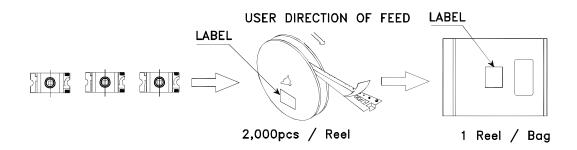
Tape Dimensions (Units: mm)

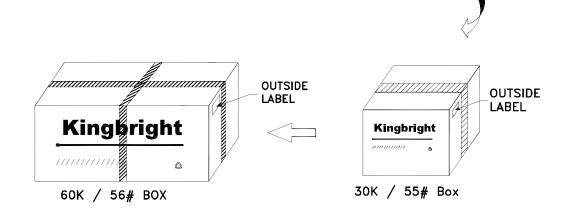


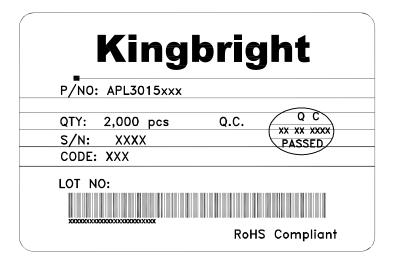
SPEC NO: DSAF1071 **REV NO: V.6B DATE: DEC/16/2012** PAGE: 4 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: C.H.Han ERP: 1203001565

PACKING & LABEL SPECIFICATIONS

APL3015CGCK-F01







All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

SPEC NO: DSAF1071 APPROVED: WYNEC REV NO: V.6B CHECKED: Allen Liu DATE: DEC/16/2012 DRAWN: C.H.Han PAGE: 5 OF 5 ERP: 1203001565